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/DN 10581127 - GAU: 2895 Sheet 1 of 2 **AP20 Rec'ú PCT/PTO 30** MAY 2006 Receipt date: 05/30/2006

FORM PTO				ATTY DOCKET NO.	SERIAL N					
INFORMATION DISCLOSURE STATEMENT				536-009.028	To be assigned 581127					
				APPLICANT: B. HEINEMANN et al.						
				FILING DATE:	ART UNIT:		Nhu			
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			UNITED STA	TES PATENT DOCUMENT	S					
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Examiner (To b	e assigned) /David	Nhu/	Date: 09/02/2	010					
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Sheet 2 of 2 AP20 Rec'd PCT/PTO 30 MAY 2006

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FORM PTO-		9 DISCLOSURE STATE	ΛFNT	ATTY DOCKET NO.	SERIAL I	SERIAL NO. To be assigned 581127				
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			UNITED STA	TES PATENT DOCUMEN	ITS					
EXAM. INITIAL		DOCUMENT NUMBER	DATE	INVENTOR/ASSIGNEE	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE			
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					Name of Street, or other Designation of the Owner, where the Parket of the Owner, where the Owner, which is the Owner, where the Owner, which is the Owner, where the Owner, which is the Owner,					
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